

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	IPT004N03L	**Issued**	24. February 2022
MA#	MA005699990		
Package	PG-HSOF-8-1	**Weight***	775.80 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	5.854	0.75	0.75	7546	7546
leadframe	inorganic material	phosphorus	7723-14-0	0.126	0.02		163	
	non noble metal	iron	7439-89-6	0.421	0.05		542	
	non noble metal	copper	7440-50-8	420.040	54.14	54.21	541429	542134
wire	non noble metal	aluminium	7429-90-5	19.016	2.45	2.45	24512	24512
encapsulation	inorganic material	zincoxide	1314-13-2	3.182	0.41		4101	
	miscellaneous	miscellaneous	-	12.727	1.64		16405	
	plastics	epoxy resin	-	47.725	6.15		61518	
	inorganic material	silicondioxide	60676-86-0	254.535	32.81	41.01	328095	410119
leadfinish	non noble metal	tin	7440-31-5	6.479	0.84	0.84	8351	8351
plating	inorganic material	phosphorus	7723-14-0	0.001			2	
	non noble metal	nickel	7440-02-0	0.526	0.07	0.07	678	680
solder	non noble metal	tin	7440-31-5	0.103	0.01		133	
	noble metal	silver	7440-22-4	0.129	0.02		166	
	non noble metal	lead	7439-92-1	4.933	0.64	0.67	6359	6658
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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